

**PATENT APPLICATION**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

*JH*

In re the Application of

Toshimichi HARADA et al.

Application No.: 09/610,305

Filed: July 5, 2000

For: THERMAL TRANSFER RECORDING MEDIA



Group Art Unit: 1771

Docket No.: 106656

**SUBMISSION OF ORIGINAL DECLARATION**

Director of the U.S. Patent and Trademark Office  
Washington, D.C. 20231

Sir:

Submitted herewith is the original signed Declaration of the Inventor. This Declaration corresponds to the facsimile copy of the Declaration filed on July 5, 2000.

Respectfully submitted,

*James A. Oliff*

James A. Oliff  
Registration No. 27,075

Thomas J. Pardini  
Registration No. 30,411

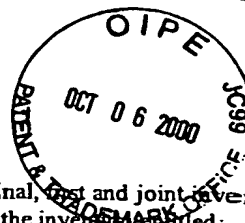
RECEIVED  
OCT 16 2000  
TC 1700 MAIL ROOM

JAO:TJP/cmm

Date: October 6, 2000

**OLIFF & BERRIDGE, PLC**  
**P.O. Box 19928**  
**Alexandria, Virginia 22320**  
**Telephone: (703) 836-6400**

# APPLICATION FOR UNITED STATES PATENT DECLARATION AND POWER OF ATTORNEY



As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; that

I verily believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: THERMAL TRANSFER RECORDING MEDIA

described and claimed in the specification:

Check one

\*a. ☐ attached hereto.

b. ☐ filed on \_\_\_\_\_ as Application No. \_\_\_\_\_ and amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

Under Title 35, U.S. Code §119, the priority benefits of the following foreign application(s) and/or United States provisional application(s) filed within one year prior to this application are hereby claimed:

Japanese Patent Application No. 11-196876 filed July 12, 1999

The following application(s) for patent or inventor's certificate on this invention were filed in countries foreign to the United States of America either (a) more than one year prior to this application, or (b) before the filing date of the above-named foreign priority application(s) and/or United States provisional application(s):

I hereby appoint the following as my attorneys of record with full power of substitution and revocation to prosecute this application and to transact all business in the Patent Office:

James A. Oliff, Reg. No. 27,075; William P. Berridge, Reg. No. 30,024;  
Kirk M. Hudson, Reg. No. 27,562; Thomas J. Pardini, Reg. No. 30,411;  
Edward P. Walker, Reg. No. 31,450; Robert A. Miller, Reg. No. 32,771 and  
Mario A. Costantino, Reg. No. 33,565.

ALL CORRESPONDENCE IN CONNECTION WITH THIS APPLICATION SHOULD BE SENT TO OLIFF & BERRIDGE, PLC, P.O. BOX 19928, ALEXANDRIA, VIRGINIA 22320, TELEPHONE (703) 836-6400.

I hereby declare that I have reviewed and understand the contents of this Declaration, and that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

1 **Typewritten Full Name  
of First or Sole Inventor**

TOSHIMICHI

HARADA

2 **\*\*Inventor's Signature:**

Given Name

Toshimichi

Middle Initial

22

Family Name

Harada

3 **\*\*Date of Signature:**

Month

June

Day

2000

Year

Residence:

TOCHIGI

JAPAN

Citizenship:

City  
JAPANESE

State or Province

Country

Post Office Address:

(Insert complete  
mailing address,  
including country)

c/o Sony Chemicals Corp. Dai-1 Factory

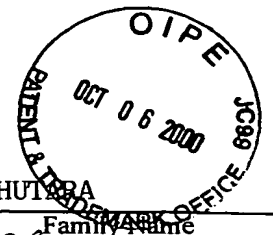
18, Satsuki-cho Kanuma-shi, Tochigi JAPAN

\*If Box (a.) is checked, this form may be executed only when attached to the specification (including claims).

\*\*Note to Inventor: Please sign name exactly as it appears above and insert actual date of signing.

IF THERE IS MORE THAN ONE INVENTOR USE PAGE 2 AND PLACE AN "X" HERE ☐

(Discard this page in a sole inventor application)



|   |  |   |  |  |
|---|--|---|--|--|
| 1 | Typewritten Full Name of Joint Inventor              | YOICHI                                    |  |  |
| 2 | Inventor's Signature:                                | SHUTARA                                   |  |  |
| 3 | Date of Signature:                                   | June 22 2000                              |  |  |
|   | Residence:   | TOCHIGI JAPAN                             |  |  |
|   | Citizenship:   | JAPANESE                                  |  |  |
|   | Post Office Address:                                 | c/o Sony Chemicals Corp. Dai-1 Factory    |  |  |
|   | (Insert complete mailing address, including country) | 18, Satsuki-cho Kanuma-shi, Tochigi JAPAN |  |  |
| 1 | Typewritten Full Name of Joint Inventor              |   |  |  |
| 2 | Inventor's Signature:                                |   |  |  |
| 3 | Date of Signature:                                   |   |  |  |
|   | Residence:   |   |  |  |
|   | Citizenship:   |   |  |  |
|   | Post Office Address:                                 |   |  |  |
|   | (Insert complete mailing address, including country) |   |  |  |
| 1 | Typewritten Full Name of Joint Inventor              |   |  |  |
| 2 | Inventor's Signature:                                |   |  |  |
| 3 | Date of Signature:                                   |   |  |  |
|   | Residence:   |   |  |  |
|   | Citizenship:   |   |  |  |
|   | Post Office Address:                                 |   |  |  |
|   | (Insert complete mailing address, including country) |   |  |  |
| 1 | Typewritten Full Name of Joint Inventor              |   |  |  |
| 2 | Inventor's Signature:                                |   |  |  |
| 3 | Date of Signature:                                   |   |  |  |
|   | Residence:   |   |  |  |
|   | Citizenship:   |   |  |  |
|   | Post Office Address:                                 |   |  |  |
|   | (Insert complete mailing address, including country) |   |  |  |

RECEIVED  
OCT 16 2000  
MAIL ROOM

Note to Inventor: Please sign name on line 2 exactly as it appears in line 1 and insert the actual date of signing on line 3.

This form may be executed only when attached to the first page of the Declaration and Power of Attorney of the application to which it pertains.